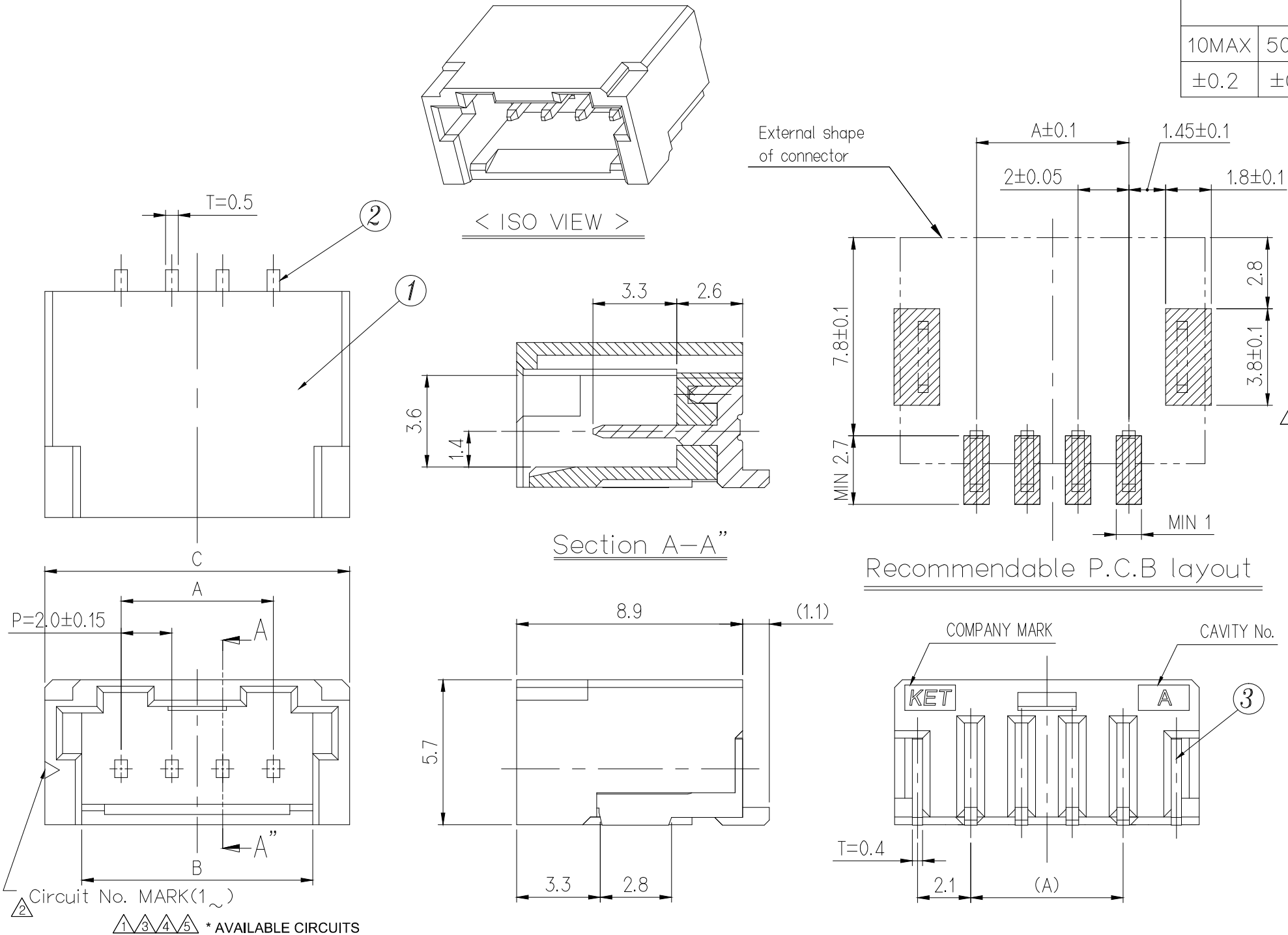


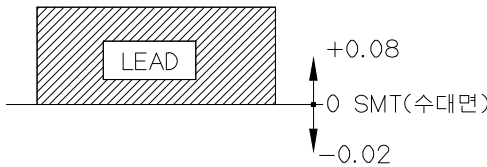


GENERAL TOLERANCE (HOUSING)							USED ON
10MAX	50MAX	100MAX	250MAX	250VR	ANGLE	ECCENT	
± 0.2	± 0.3	± 0.55	± 0.95	± 1.4	$\pm 30'$	0.1	

- △ 주 기
- 기능상 유해한 BURR 및 WELDLINE 등이 없을 것.
 - 제품 내 함유된 10대 유해물질 (Pb, Hg, Cd, Cr+6, PBBs, PBDEs, DEHP, DBP, BBP, DIBP)은 EU ELV 지침 및 RoHS 법규에서 지정한 최대 허용 농도를 초과해서는 안된다.
 - 포장사양 : EMOSS TAPE
 - ES91500-03 / E91500-02 / MS201-02 SPEC.에 준할 것.

- △ NOTE
- MUST BE FREE OF BURR, WELDLINE AND IMPERFECTION THAT AFFECT FUNTION.
 - 10 HAZARDOUS SUBSTANCES IN PARTS (Pb, Hg, Cd, Cr+6, PBBs, PBDEs, DEHP, DBP, BBP, DIBP) SHALL NOT EXCEED THE MAXIMUM PERMISSIBLE CONCENTRATION PRESCRIBED UNDER EU ELV DIRECTIVE & RoHS REGULATION
 - PACKAGE : EMOSS TAPE
 - MUST BE SATISFIED WITH ES91500-03 / E91500-02 / MS201-02 SPEC

* LEAD 평탄도 관리 치수 (COPLANARITY OF SOLDER TAILS)



Circuits (N)	Part No.		Color(**)					Dimension			Remark
			Natural	Blue	Yellow	Black	Brown	A	B	C	
2	Sn	K500024-**-	02	2	3	5	-	2.0	5.1	8.0	-
	Au	MG645959-*	Blank								
3	Sn	K500025-**-	03	2	3	5	-	4.0	7.1	10.0	-
	Au	MG645960-*	Blank								
4	Sn	K500026-**-	04	2	3	5	-	6.0	9.1	12.0	-
	Au	MG645899-*	Blank								
5	Sn	MG646220-*	Blank	2	-	5	-	8.0	11.1	14.0	-
	Au	MG646239-*									
	Sn	MG646467-*	-								
	Au	MG646457-*	-								
6	Sn	K500027-**-	06	2	3	5	-	10.0	13.1	16.0	-
	Au	MG645961-*	Blank								
7	Sn	MG646235-*	Blank	2	-	5	-	12.0	15.1	18.0	-
	Au	MG646240-*									
8	Sn	MG646236-*	Blank	2	-	5	-	14.0	17.1	20.0	-
	Au	MG646241-*									
9	Sn	MG646237-*	Blank	2	-	5	-	16.0	19.1	22.0	-
	Au	MG646242-*									
10	Sn	MG646238-*	Blank	2	-	5	-	18.0	21.1	24.0	-
	Au	MG646243-*									

3	METAL FITTING	COPPER ALLOY(t=0.4)	-	Ni+Sn	2	
2	CONTACT	COPPER ALLOY(t=0.5)	-	Ni+Sn / Ni+Au	N	
1	HOUSING	NYLON	SEE TABLE	-	1	
No.	Part Name	Material	Color	Finish	Q'ty	Remark
5	7P HZT Au 신규 품번 추가	LKN YSW	SSH	21.08.13	MATERIAL	SEE TABLE
4	5P HZT Sn KEY CODE 추가	LKN YSW	SSH	20.11.27	FINISH	SEE TABLE
3	5P HZT Au KEY CODE 추가	LKN YSW	SSH	20.09.11	WIRE RANGE	WIRE RANGE
2	Circuit No. Mark 추가	LKN	SSH	19.06.24	INSULATION	INSULATION
1	품번 추가 및 Note 변경	LKN	SSH	19.05.16		
LTR	REVISION RECORD	DR.	CHK.	APP.	DATE	
DR.	HC. KWON 2012.03.14	CHK.	YJ.JO 2012.03.14			
CHK.		APP.	WC.BAEK 2012.03.14			
				TOLERANCE EXCEPT AS NOTED	SEE TABLE	SCALE 5/1
				PART NAME	2.0mm Wire to Board WAFER ASSY HZT	



ISSUE MARK

KET KOREA ELECTRIC
ENGINEERED TERMINAL CO., LTD.

CLASS Wire to Board Connector

TYPE 2.0mm Pitch SMD

PART NO. SEE TABLE